

**2018 FLORIDA NOT FOR PROFIT CORPORATION ANNUAL REPORT**

DOCUMENT# N08000005306

**FILED**  
**Jan 15, 2018**  
**Secretary of State**  
**CC3273349030**

**Entity Name:** HIGH PRESSURE SCIENCE SOCIETY OF AMERICA CORPORATION

**Current Principal Place of Business:**

CESMEC, VH-140, FLORIDA INTERNATIONAL UNIV  
UNIVERSITY PARK, SW11200 AVE  
MIAMI, FL 33199

**Current Mailing Address:**

CESMEC, VH-140, FLORIDA INTERNATIONAL UNIV  
UNIVERSITY PARK, SW11200 AVE  
MIAMI, FL 33199

**FEI Number: 36-4635785**

**Certificate of Status Desired: No**

**Name and Address of Current Registered Agent:**

SAXENA, MAYA  
SAXENA-WHITE PA  
SAXENA WHITE P.A 150 EAST PALMETTO PARK ROAD SUITE 600 BOCA RATON, FL  
33432 (561) 869-1013 (DIRECT) 150 EAST PALMETTO PARK ROAD  
BOCA RATON, FL 33432 US

*The above named entity submits this statement for the purpose of changing its registered office or registered agent, or both, in the State of Florida.*

**SIGNATURE:** \_\_\_\_\_

Electronic Signature of Registered Agent

\_\_\_\_\_ Date

**Officer/Director Detail :**

Title P  
Name SAXENA, S.K. DR.  
Address CESMEC, FIU, UNIVERSITY PARK  
City-State-Zip: MIAMI FL 33199

Title S  
Name CHEN, J DR.  
Address CESMEC, FIU, UNIVERSITY PARK  
City-State-Zip: MIAMI FL 33199

Title T  
Name DURYGIN, A DR.  
Address CESMEC, FIU, UNIVERSITY PARK  
City-State-Zip: MIAMI FL 33199

Title D  
Name MAO, H K DR.  
Address GEOPHYSICAL LABORATORY, CIW  
City-State-Zip: WASHINGTON DC

Title D  
Name SHEN, G DR.  
Address HPCAT, ADVANCED PHOTON SOURCE, ARGONNE  
City-State-Zip: ARGONNE IL

*I hereby certify that the information indicated on this report or supplemental report is true and accurate and that my electronic signature shall have the same legal effect as if made under oath; that I am an officer or director of the corporation or the receiver or trustee empowered to execute this report as required by Chapter 617, Florida Statutes; and that my name appears above, or on an attachment with all other like empowered.*

**SIGNATURE: SAXENA , S.K. DR.**

**PRESIDENT**

**01/15/2018**

